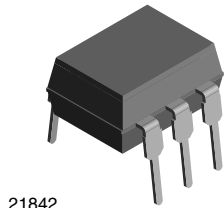
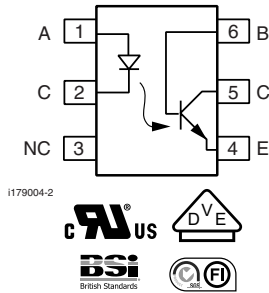


## Optocoupler, Phototransistor Output, with Base Connection



21842



1179004-2



### FEATURES

- Isolation test voltage 5000 V<sub>RMS</sub>
- Long term stability
- Industry standard dual-in-line package
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC



RoHS COMPLIANT

### AGENCY APPROVALS

- Underwriters lab file no. E52744
- DIN EN 60747-5-5 (VDE 0884)
- BSI IEC 60950 IEC 60065
- FIMKO

### DESCRIPTION

The CNY17 is an optically coupled pair consisting of a gallium arsenide infrared emitting diode optically coupled to a silicon NPN phototransistor.

Signal information, including a DC level, can be transmitted by the device while maintaining a high degree of electrical isolation between input and output.

The CNY17 can be used to replace relays and transformers in many digital interface applications, as well as analog applications such as CRT modulation.

ORDER INFORMATION	
PART	REMARKS
CNY17-1.	CTR 40 % to 80 %, DIP-6
CNY17-2.	CTR 63 % to 125 %, DIP-6
CNY17-3.	CTR 100 % to 200 %, DIP-6
CNY17-4.	CTR 160 % to 320 %, DIP-6

ABSOLUTE MAXIMUM RATINGS <sup>(1)</sup>				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
<b>INPUT</b>				
Reverse voltage		V <sub>R</sub>	5	V
Forward current		I <sub>F</sub>	60	mA
Surge current	t ≤ 10 μs	I <sub>FSM</sub>	3	A
Power dissipation		P <sub>diss</sub>	100	mW
<b>OUTPUT</b>				
Collector emitter breakdown voltage		BV <sub>CEO</sub>	70	V
Emitter base breakdown voltage		BV <sub>EBO</sub>	7	V
Collector current		I <sub>C</sub>	50	mA
	t < 1 ms	I <sub>C</sub>	100	mA
Power dissipation		P <sub>diss</sub>	150	mW

**Optocoupler, Phototransistor Output, Vishay Semiconductors  
with Base Connection**

<b>ABSOLUTE MAXIMUM RATINGS (1)</b>				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
<b>COUPLER</b>				
Isolation test voltage between emitter and detector referred to climate DIN 50014, part 2, Nov. 74	t = 1 s	V <sub>ISO</sub>	5000	V <sub>RMS</sub>
Creepage distance			≥ 7	mm
Clearance distance			≥ 7	mm
Isolation thickness between emitter and detector			≥ 0.4	mm
Comparative tracking index per DIN IEC 112/VDE 0303, part 1			175	
Isolation resistance	V <sub>IO</sub> = 500 V, T <sub>amb</sub> = 25 °C	R <sub>IO</sub>	≥ 10 <sup>12</sup>	Ω
	V <sub>IO</sub> = 500 V, T <sub>amb</sub> = 100 °C	R <sub>IO</sub>	≥ 10 <sup>11</sup>	Ω
Storage temperature		T <sub>stg</sub>	- 55 to + 125	°C
Operating temperature		T <sub>amb</sub>	- 55 to + 100	°C
Soldering temperature (2)	max. 10 s, dip soldering: distance to seating plane ≥ 1.5 mm	T <sub>slid</sub>	260	°C

**Notes**(1) T<sub>amb</sub> = 25 °C, unless otherwise specified.

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

(2) Refer to wave profile for soldering conditions for through hole devices.

<b>ELECTRICAL CHARACTERISTICS (1)</b>							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>INPUT</b>							
Forward voltage	I <sub>F</sub> = 60 mA		V <sub>F</sub>		1.25	1.65	V
Breakdown voltage	I <sub>R</sub> = 10 mA		V <sub>BR</sub>	6			V
Reverse current	V <sub>R</sub> = 6 V		I <sub>R</sub>		0.01	10	μA
Capacitance	V <sub>R</sub> = 0 V, f = 1 MHz		C <sub>O</sub>		25		pF
Thermal resistance			R <sub>th</sub>		750		K/W
<b>OUTPUT</b>							
Collector emitter capacitance	V <sub>CE</sub> = 5 V, f = 1 MHz		C <sub>CE</sub>		5.2		pF
Collector base capacitance	V <sub>CB</sub> = 5 V, f = 1 MHz		C <sub>CB</sub>		6.5		pF
Emitter base capacitance	V <sub>EB</sub> = 5 V, f = 1 MHz		C <sub>EB</sub>		7.5		pF
Thermal resistance			R <sub>th</sub>		500		K/W
<b>COUPLER</b>							
Collector emitter, saturation voltage	V <sub>F</sub> = 10 mA, I <sub>C</sub> = 2.5 mA		V <sub>CEsat</sub>		0.25	0.4	V
Coupling capacitance			C <sub>C</sub>		0.6		pF
Collector emitter, leakage current	V <sub>CE</sub> = 10 V	CNY17-1	I <sub>CEO</sub>		2	50	nA
		CNY17-2	I <sub>CEO</sub>		2	50	nA
		CNY17-3	I <sub>CEO</sub>		5	100	nA
		CNY17-4	I <sub>CEO</sub>		5	100	nA

**Note**(1) T<sub>amb</sub> = 25 °C, unless otherwise specified.

Minimum and maximum values were tested requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO (1)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
$I_C/I_F$	$V_{CE} = 5\text{ V}, I_F = 10\text{ mA}$	CNY17-1	CTR	40		80	%
		CNY17-2	CTR	63		125	%
		CNY17-3	CTR	100		200	%
		CNY17-4	CTR	160		320	%
	$V_{CE} = 5\text{ V}, I_F = 1\text{ mA}$	CNY17-1	CTR	13	30		%
		CNY17-2	CTR	22	45		%
		CNY17-3	CTR	34	70		%
		CNY17-4	CTR	56	90		%

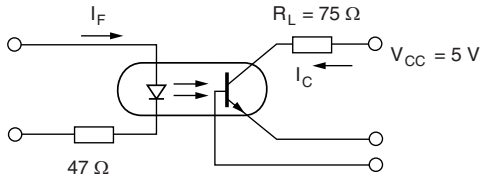
**Note**

(1) Current transfer ratio and collector-emitter leakage current by dash number ( $T_{amb}$  °C).

SWITCHING CHARACTERISTICS							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>LINEAR OPERATION (WITHOUT SATURATION)</b>							
Turn-on time	$I_F = 10\text{ mA}, V_{CC} = 5\text{ V}, R_L = 75\ \Omega$		$t_{on}$		3		$\mu\text{s}$
Rise time	$I_F = 10\text{ mA}, V_{CC} = 5\text{ V}, R_L = 75\ \Omega$		$t_r$		2		$\mu\text{s}$
Turn-off time	$I_F = 10\text{ mA}, V_{CC} = 5\text{ V}, R_L = 75\ \Omega$		$t_{off}$		2.3		$\mu\text{s}$
Fall time	$I_F = 10\text{ mA}, V_{CC} = 5\text{ V}, R_L = 75\ \Omega$		$t_f$		2		$\mu\text{s}$
Cut-off frequency	$I_F = 10\text{ mA}, V_{CC} = 5\text{ V}, R_L = 75\ \Omega$		$f_{CO}$		250		kHz
<b>SWITCHING OPERATION (WITH SATURATION)</b>							
Turn-on time	$I_F = 20\text{ mA}$	CNY17-1	$t_{on}$		3		$\mu\text{s}$
	$I_F = 10\text{ mA}$	CNY17-2	$t_{on}$		4.2		$\mu\text{s}$
		CNY17-3	$t_{on}$		4.2		$\mu\text{s}$
		CNY17-4	$t_{on}$		6		$\mu\text{s}$
Rise time	$I_F = 20\text{ mA}$	CNY17-1	$t_r$		2		$\mu\text{s}$
	$I_F = 10\text{ mA}$	CNY17-2	$t_r$		3		$\mu\text{s}$
		CNY17-3	$t_r$		3		$\mu\text{s}$
		CNY17-4	$t_r$		4.6		$\mu\text{s}$
Turn-off time	$I_F = 20\text{ mA}$	CNY17-1	$t_{off}$		18		$\mu\text{s}$
	$I_F = 10\text{ mA}$	CNY17-2	$t_{off}$		23		$\mu\text{s}$
		CNY17-3	$t_{off}$		23		$\mu\text{s}$
		CNY17-4	$t_{off}$		25		$\mu\text{s}$
Fall time	$I_F = 20\text{ mA}$	CNY17-1	$t_f$		11		$\mu\text{s}$
	$I_F = 10\text{ mA}$	CNY17-2	$t_f$		14		$\mu\text{s}$
		CNY17-3	$t_f$		14		$\mu\text{s}$
		CNY17-4	$t_f$		15		$\mu\text{s}$

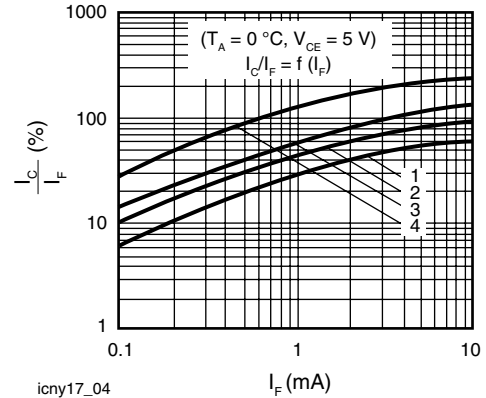
**TYPICAL CHARACTERISTICS**

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified



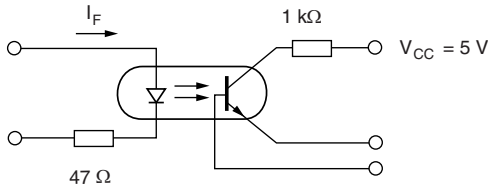
icny17\_01

Fig. 1 - Linear Operation (without Saturation)



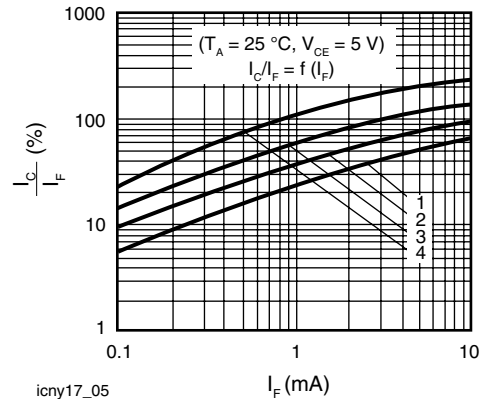
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Fig. 4 - Current Transfer Ratio vs. Diode Current



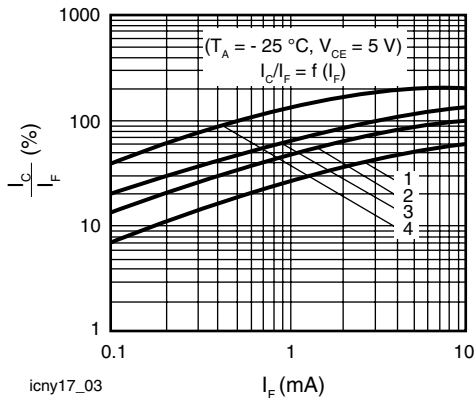
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Fig. 2 - Switching Operation (with Saturation)



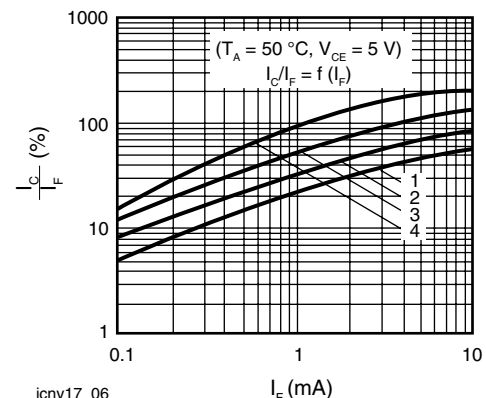
icny17\_05

Fig. 5 - Current Transfer Ratio vs. Diode Current



icny17\_03

Fig. 3 - Current Transfer Ratio vs. Diode Current



icny17\_06

Fig. 6 - Current Transfer Ratio vs. Diode Current

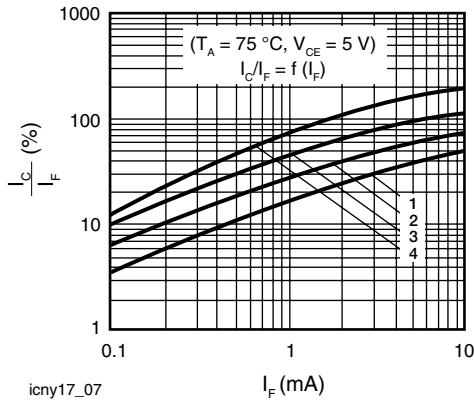


Fig. 7 - Current Transfer Ratio vs. Diode Current

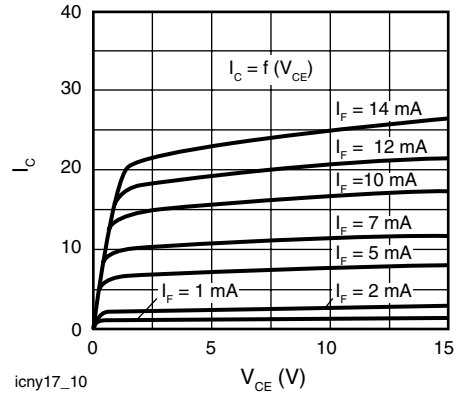


Fig. 10 - Output Characteristics

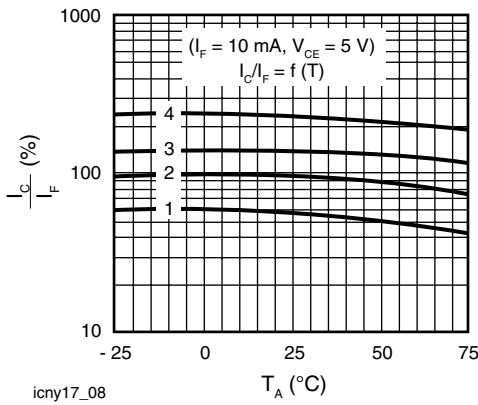


Fig. 8 - Current Transfer Ratio (CTR) vs. Temperature

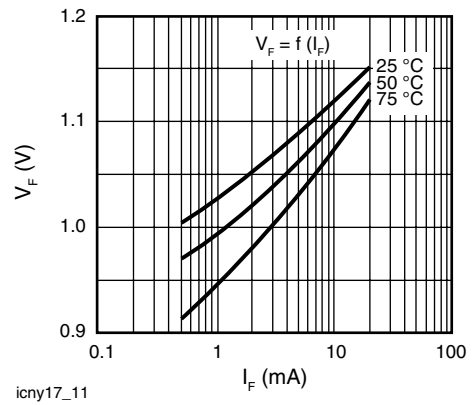


Fig. 11 - Forward Voltage

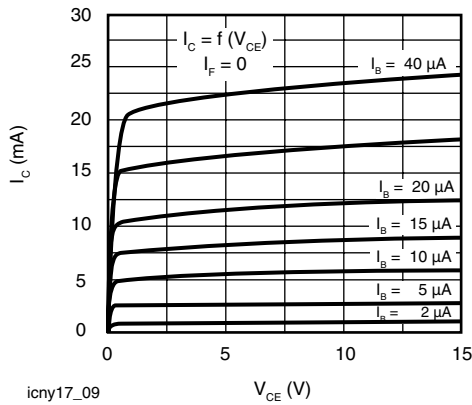


Fig. 9 - Transistor Characteristics

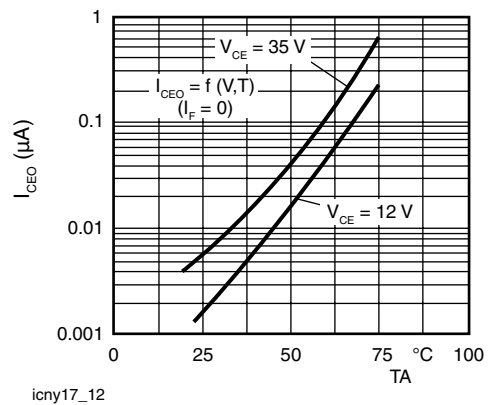


Fig. 12 - Collector Emitter Off-state Current

Optocoupler, Phototransistor Output, Vishay Semiconductors with Base Connection

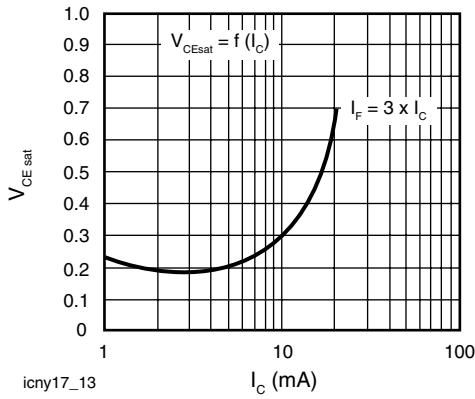


Fig. 13 - Saturation Voltage vs. Collector Current and Modulation Depth CNY17-1

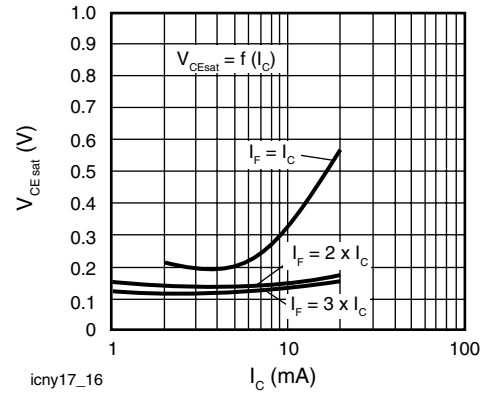


Fig. 16 - Saturation Voltage vs. Collector Current and Modulation Depth CNY17-4

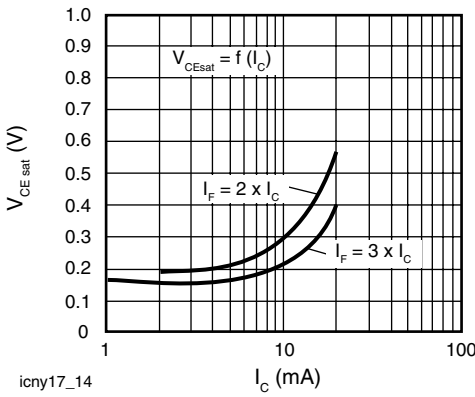


Fig. 14 - Saturation Voltage vs. Collector Current and Modulation Depth CNY17-2

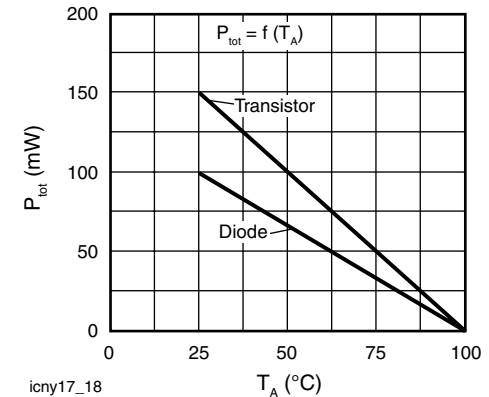


Fig. 17 - Permissible Power Dissipation for Transistor and Diode

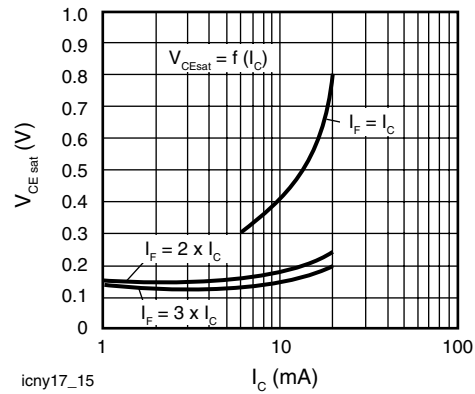


Fig. 15 - Saturation Voltage vs. Collector Current and Modulation Depth CNY17-3

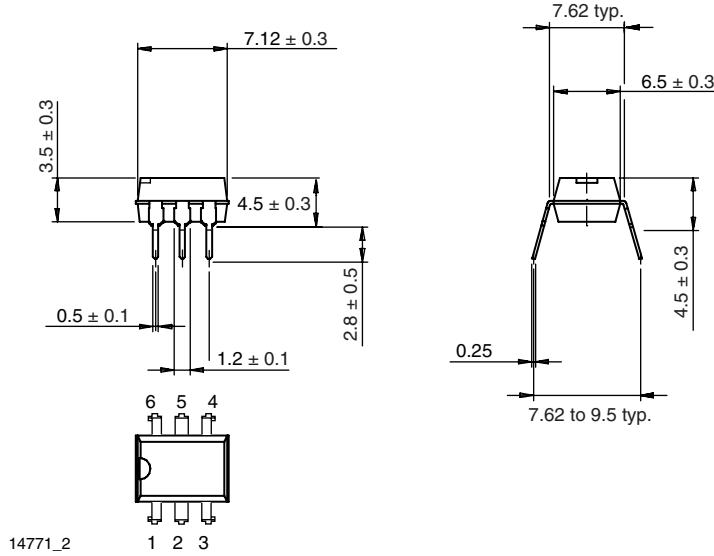
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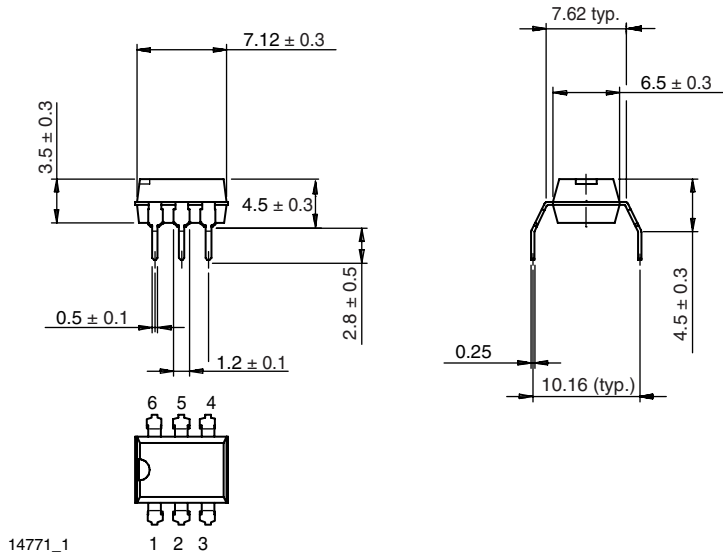
Vishay Semiconductors Optocoupler, Phototransistor Output,  
with Base Connection

## PACKAGE DIMENSIONS in millimeters

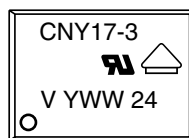
DIP-6



DIP-6, 400 mil



## PACKAGE MARKING





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